

**MECHANICAL DATA** 

Module dimension

Viewing area Active area

Dot size

Dot pitch

Mounting hole

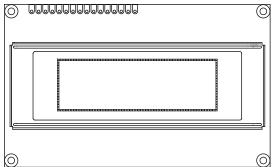
**ITEM** 

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COMPLIANT

### 100 x 32 Graphic OLED



#### **FEATURES**

• Type: graphic

• Display format: 100 x 32 dots • Built-in controller: OLED-0010

• Duty cycle: 1/16

• +5 V power supply • Interface: 6800

• Material categorization: for definitions of compliance

please see www.vishav.com/doc?99912

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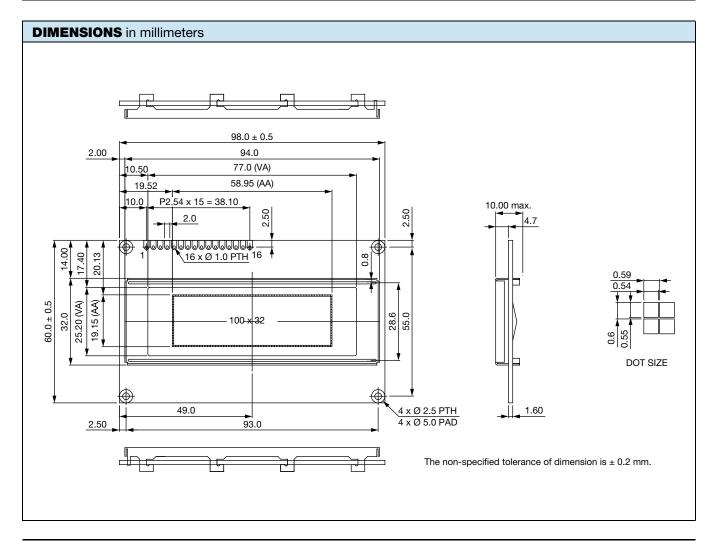
ATA		ABSOLUTE I	MAXIMUM	RATING	is		
STANDARD VALUE	UNIT		ITEM SYMBOL -	STANDAF	LINUT		
98.0 x 60.0 x 10.0 (max.)				STIVIBOL	MIN.	MAX.	UNIT
77.0 x 25.20			Supply voltage	V <sub>DD</sub> to V <sub>SS</sub>	-0.3	5.3	V
58.95 x 19.15			for logic	DD - 00			
0.54 x 0.55	mm		Operating temperature	T <sub>OP</sub>	-40	+80	
0.59 x 0.60			Storage	-	40	00	°C
93.0 x 55.0			temperature	T <sub>STG</sub>	-40	+80	

ELECTRICAL CHARACTERISTICS											
ITEM	CVMPOL CONDITION		ST	STANDARD VALUE							
HEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT					
Supply voltage for logic	V <sub>DD</sub> to V <sub>SS</sub>	-	4.8	5.0	5.3						
Input high voltage	V <sub>IH</sub>	-	0.8 V <sub>DD</sub>	-	$V_{DD}$						
Input low voltage	V <sub>IL</sub>	-	GND	-	0.2 V <sub>DD</sub>	V					
Output high voltage	V <sub>OH</sub>	I <sub>OH</sub> = -0.5 mA	0.8 V <sub>DD</sub>	-	$V_{DD}$						
Output low voltage	V <sub>OL</sub>	I <sub>OL</sub> = 0.5 mA	GND	-	0.2 V <sub>DD</sub>						
50 % check board operating current	I <sub>DD</sub>	V <sub>DD</sub> = 5 V	50	54	62	mA					

When you use 5 V for V<sub>DD</sub>, please do not use 3 V or 3.3 V for logic I/O, this will cause module does not work.

OPTIONS										
	EMITTING COLOR									
YELLOW	GREEN	RED	BLUE	WHITE						
Yes	-	-	-	-						

INTERFACE PI	N FUNCTION	
PIN NO.	SYMBOL	FUNCTION
1	V <sub>SS</sub>	Ground (0 V)
2	V <sub>DD</sub>	Supply voltage for logic (5.0 V)
3	NC	No connection
4	RS	H / L, H: data; L: instruction code
5	R/W	H / L, H: read (module $\rightarrow$ MPU); L: write (MPU $\rightarrow$ module)
6	E	$H, H \rightarrow L$ , chip enable signal
7	DB0	H / L, data bit 0
8	DB1	H / L, data bit 1
9	DB2	H / L, data bit 2
10	DB3	H / L, data bit 3
11	DB4	H / L, data bit 4
12	DB5	H / L, data bit 5
13	DB6	H / L, data bit 6
14	DB7	H / L, data bit 7
15	CS1	Chip 1 select input pin
16	CS2	Chip 2 select input pin



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### 1. Module Classification Information

<u>OLED - 100 H 032 A - L P P 5 N 00000</u>

1 2 3 4 5 6 7 8 9 10 11

1	Brand : Vishay Intertechnology, Inc.								
2	Horizontal Format: 100 columns								
3	Display Type:N→Character Type, H→Graphic Type ,Y→TAB Type								
4	Vertical Format: 32 lines/rows								
5	Series code:	Α							
		A : Amber	R : RED						
	Emitting	B: Blue	C : Full color						
6	Color	G: Green	W: White						
		Y: Yellow Green	L: Yellow						
7	Polarizer	P:With Polarizer; N: Without F	Polarizer						
8	Display Mode	P : Passive Matrix ; A: Action M	latrix						
9	Driver Voltage	3: 3.0 V; 5: 5.0V							
10	Touch Panel	N : Without touch panel; T: With	N:Without touch panel; T: With touch panel						
11	Serial No.	00000: Application Serial Numb	er / Sales Code						



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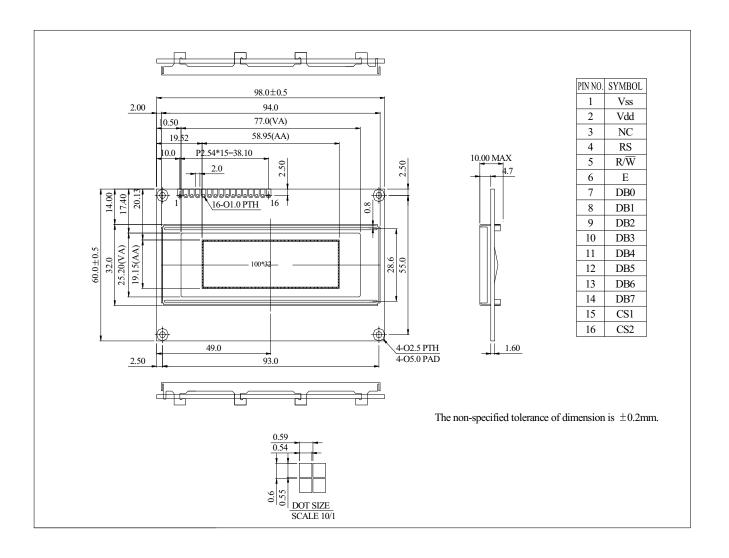
### 2.General Specification

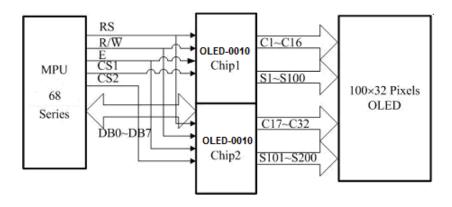
Item	Dimension	Unit
Dot Matrix	100x 32 Dots	_
Module dimension	98.0 x 60.0 x 10.0(MAX)	mm
View area	77.0x25.20	mm
Active area	58.95 x 19.15	mm
Dot size	0.54 x 0.55	mm
Dot pitch	0.59x 0.60	mm
Panel Type	OLED , Yellow	
Duty	1/16	



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## 3. Contour Drawing & Block Diagram





Ad	Address Format					Т	B7		B6	DB5	DB4	D	B3	DI	B2	DI	B1	DE	30
GXA(Gra				ldre	SS		1	ΑI	DD6	ADD5	ADD4	ΑE	D3		D2	AD	D1	AD	50000000
GYA(Gra	aphic Y	axis	s Ac	dre	ss		0		1	0	0		0	(	0	(	)	CG	A0
		1	1	2	2	3	}					9	7	9	8	9	9	10	00
CS1=0 CS2=1	CGA=0	GXA=100000000	GYA=010000000	GXA=100000001	GYA=010000000			GXA=10000011	GYA=01000000	,			GYA=010000000		GYA=010000000		GYA=010000000		GYA=010000000
	CGA=1	GXA=100000000	GYA=01000001	GXA=10000001 GXA=10000001	GYA=01000001 GYA=01000000	GXA=10000010 GXA=10000010	GYA=01000001 GYA=01000000	GXA=10000011 GXA=10000011	GYA=01000001			GXA=11100000 GXA=11100000	GYA=01000001	GXA=11100001 GXA=11100001	GYA=010000001	GXA=11100010 GXA=11100010	GYA=010000001	GXA=11100011 GXA=11100011	GYA=010000001
		1	1	2	2	(3)	3	4				9	7	9	8	9	9	10	00
CS1=1	CGA=0	GXA=10000000 GXA=10000000	GYA=01000000	GXA=10000001	GYA=01000000	GXA=10000010	GYA=010000000	GXA=10000011	GYA=01000000			GXA=11100000 GXA=11100000	GYA=01000000	GXA=11100001	GYA=01000000	GXA=11100010 GXA=11100010	GYA=01000000	1000	GYA=01000000
CS1=1 CS2=0	CGA=1	GXA=100000000	GYA=01000001	GXA=10000001 GXA=10000001	GYA=01000001	GXA=10000010 GXA=10000010	GYA=01000001	GXA=10000011 GXA=10000011	GYA=01000001			GXA=11100000	GYA=01000001	GXA=11100001 GXA=11100001	GYA=01000001	GXA=11100010	GYA=01000001	GXA=11100011 GXA=11100011	GYA=01000001

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### **4.Interface Pin Function**

Pin No.	Symbol	Level	Description
1	VSS	0V	Ground
2	VDD	5.0V	Supply Voltage for logic
3	NC	_	
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(Module→MPU) L: Write(MPU→Module)
6	E	H,H→L	Chip enable signal
7	DB0	H/L	Data bit 0
8	DB1	H/L	Data bit 1
9	DB2	H/L	Data bit 2
10	DB3	H/L	Data bit 3
11	DB4	H/L	Data bit 4
12	DB5	H/L	Data bit 5
13	DB6	H/L	Data bit 6
14	DB7	H/L	Data bit 7
15	CS1	_	Chip1 select input pin
16	CS2	_	Chip2 select input pin



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### 5.Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Notes
Operating Temperature	Тор	-40	+80	$^{\circ}$ C	
Storage Temperature	Тѕт	-40	+80	$^{\circ}\!\mathbb{C}$	
Supply Voltage For Logic	VDD-V <sub>SS</sub>	-0.3	5.3	V	



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### **6.Electrical Characteristics**

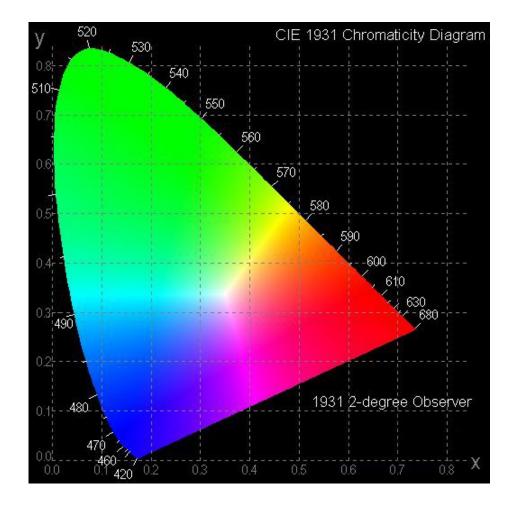
Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	VDD-VSS		4.8	5.0	5.3	V
Input High Volt.	VIH	_	0.8 VDD	_	VDD	V
Input Low Volt.	VIL	_	GND	_	0.2 VDD	V
Output High Volt.	VOH	IOH=-0.5mA	0.8 VDD	_	VDD	V
Output Low Volt.	VOL	IOL=0.5mA	GND	_	0.2 VDD	V
50% Check Board Operating Current	IDD	VDD=5V	50	54	62	mA

Note: When you use 5V for Vdd please don't use 3V or 3.3V for logic I/O this will cause module does not work.



### 7. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Viou Anglo	(V)θ		160			deg
View Angle	(Η)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		_	_
Poononoo Timo	T rise	_		10		μs
Response Time	T fall	_		10		μs
Display with 50% check Bo	ard Brightness	1	70	80		cd/m2
CIEx(Yellow)	(CIE1931)	0.45	0.47	0.49		
CIEy(Yellow)		(CIE1931)	0.48	0.50	0.52	





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### **8.OLED Lifetime**

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°ℂ / Initial 50% check board brightness Typical Value	80,000 Hrs	100,000 Hrs	Note

#### Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.



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### 9. Reliability

**Content of Reliability Test** 

Environmenta	I Test		
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80□ 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40□ 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80□ 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40□ 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60□,90%RH 240hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle.  -40 25 80  30min 5min 30min 1 cycle	-40□/80□ 100 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr	
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction	
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	
Others			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

<sup>\*\*\*</sup> Supply voltage for OLED system =Operating voltage at 25 $^{\circ}$ C

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#### Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

#### **Evaluation criteria**

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

#### **APPENDIX:**

#### **RESIDUE IMAGE**

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



### **10.Inspection Specification**

NO	Item	Criterion				AQL
01	Electrical Testing	<ol> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 OLED viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ol>			0.65	
02	Black or white spots on OLED (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm.</li> </ul>		2.5		
03	OLED black spots, white spots, contamina tion (non-displ ay)	3.1 Round type : As following drawing Φ=(x+y)/2  X  Y	S	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2	2.5
04	Polarizer bubbles	<u></u>	ength	drawing) Width $W \le 0.02$ $0.02 < W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W$ Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense  2 As round type  Acceptable Q TY Accept no dense  3 2 0	2.5



NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination			
			t: Glass thickness a	Chip thickness : OLED side length	
		6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels:			
				THE PARTY OF THE P	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x≦1/8a	2.5
	glass	1/2t <z≦2t< td=""><td>Not exceed 1/3k</td><td>x≦1/8a</td><td>2.5</td></z≦2t<>	Not exceed 1/3k	x≦1/8a	2.5
⊙ If there are 2 or more chips, x is total length of each chip 6.1.2 Corner crack:					
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x≦1/8a	
		1/2t <z≦2t< td=""><td>Not exceed 1/3k</td><td>x≦1/8a</td><td></td></z≦2t<>	Not exceed 1/3k	x≦1/8a	
		⊙ If there are 2 or mo	ore chips, x is the tota	Il length of each chip.	



NO	140.00	Cuitanian	AOI
NO	Item	Criterion Symbols:	AQL
		x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:	
		6.2.2 Non-conductive portion:	
06	Glass crack	y Z Z X Z Z X X Z Z Z X X Z Z Z Z Z Z Z	2.5
		y: Chip width x: Chip length z: Chip	
		$ \begin{array}{ c c c c c c }\hline & & thickness\\ y \le L & x \le 1/8a & 0 < z \le t \end{array} $	
		○ If the chipped area touches the ITO terminal, over 2/3 of the ITO	
		must remain and be inspected according to electrode terminal	
		specifications.	
		⊙ If the product will be heat sealed by the customer, the alignment	
		mark not be damaged.	
		6.2.3 Substrate protuberance and internal crack.	
		y: width x: length	
		$y \le 1/3L$ $x \le a$	
		У	
		\$6°	
	<u> </u>		1





NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	2.5 0.65
10	PCB、COB	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> </ul>	2.5 2.5 0.65 2.5 2.5 0.65 2.5
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65





NO	Item	Criterion	AQL
NO 12	General appearance	<ul> <li>Criterion</li> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> <li>12.9 OLED pin loose or missing pins.</li> <li>12.10 Product packaging must the same as specified on packaging specification sheet.</li> <li>12.11 Product dimension and structure must conform to</li> </ul>	AQL 2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65
		product specification sheet.	

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Pixel C Light Pixel

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### 11.Precautions in Use of OLED Modules

#### **Modules**

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please store in anti-static electricity container and clean environment.
- (8)Use a "Screen Saver" to extend the lifetime. Do not show fixed information for a long time in the application.
- (9)Don't use fixed information in OLED panel for long time that will cause "screen burn" effect.
- (10)The manufacturer has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11)The manufacturer has the right to change the PCB Rev. (In order to satisfy supply stability, management optimization, and the best product performance..., under the premise of not affecting the electrical characteristics and external dimensions. The manufacturer has the right to modify the version.)

#### 11.1. Handling Precautions

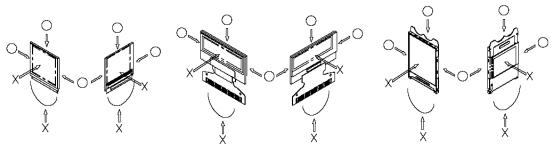
- (1) Since the display panel is made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale or ingest the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent
  - Never try to breathe upon the soiled surface or wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvents can damage the polarizer:

- \* Water
- \* Ketone
- \* Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.
  - These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



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- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble or modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- \* Be sure to make human body grounding when handling OLED display modules.
- \* Be sure to ground tools to use or assembly such as soldering irons.
- \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- \* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when removing the protective film.
- (11) Protective film is applied to the surface of the display panel. Remove the protective film before assembly. If the OLED display module has been stored for a long period of time, residue adhesive material from the protective film may remain on the surface of the display panel after the film is removed. In such case, remove the residue material by the method introduced in the above Section 5.
- (12) If electric current is applied when the OLED display module has moisture condensation or when it is placed under high humidity environments, the electrodes may corrode.

#### 11.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light and fluorescent lamps. Avoid high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend storing these modules in the packaged state as they were shipped.)
At that time, be careful not to let water drops adhere to the packages or bags or let condensation occur with them.

(2) If electric current is applied when condensation is present or when it is placed under high humidity environments, the electrodes may corrode.

#### 11.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) For EMI, take necessary measures in the application equipment.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.

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\* Connection (contact) to any other potential than the above may lead to rupture of the IC.11.4.

#### Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

#### 11.5. Other Precautions

- (1) When an OLED display module is operated for a long time with a fixed pattern, the pattern may remain as an after image with slight contrast or brightness variation.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- \* Pins and electrodes
- \* Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is exposed. Generally, semiconductor elements change their characteristics when exposed to light, similar to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- \* Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- \* Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operational state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal states may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7) The manufacturer has the right to upgrade and modify the product function.



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